

# SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

CUSTOMER :

(客戶): 志盛翔

DATE: (日期):2018-06-22

CATEGORY (品名)	:	ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	:	GF 50V470μF(φ10x20)
VERSION (版本)	:	01
Customer P/N	:	
SUPPLIER	:	

SUPPL	IER	CUSTO	OMER
PREPARED (拟定)	CHECKED (审核)	APPROVAL (批准)	SIGNATURE (签名)
孟庆庆	刘渭清		

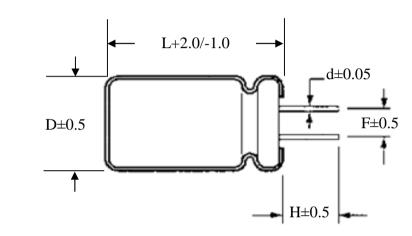
#### ELECTROLYTIC CAPACITOR SPECIFICATION GF SERIES

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MAN YUE ELECTRONICS	ELECTROLYTIC CAPACITOR	SAMXON
COMPANY LIMITED	SPECIFICATION GF SERIES	

#### Table 1 Product Dimensions and Characteristics



 D
 10

 Shape Code
 L
 20

 L
 20
 F
 5.0

 CB Type
 H
 3.5
 d

 d
 0.6
 0.6
 0.6

Table 1

N	SAMXON	WV	Cap.	Cap.	Temp.			<b>Current at</b> $105^{\circ}$ at $20^{\circ}$		Load lifetime	Dimension (mm)			Sleeve
0.	Part No.	(Vdc)	(µF)	tolerance	range (℃)	z,20 ℃)	(µA,2mi n)	100kHz (mA rms)	100kHz (Ωmax)	(Hrs)	D×L	F	фd	510000
1	EGF477M1HG20CB**P	50	470	-20%~+20%	-40~105	0.10	235	1220	0.060	3000	10X20	5.0	0.6	PET

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Unit: mm

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<ol> <li>Part Number System</li> <li>Construction</li> <li>Construction</li> <li>Characteristics</li> <li>Characteristics</li> <li>Characteristics</li> <li>Rated voltage &amp; Surge voltage</li> <li>Capacitance (Tolerance)</li> <li>Leakage current</li> <li>Lakage current</li> <li>Lakage current</li> <li>Impedance</li> <li>Forminal strength</li> <li>Temperature characteristic</li> <li>Load life test</li> <li>Shelf life test</li> <li>Solderability test</li> <li>Solderability test</li> <li>Solderability test</li> <li>Solderability test</li> <li>Solderability test</li> <li>Tomp heat test</li> <li>Vort test</li> <li>Vort test</li> <li>Solderability test</li> <li></li></ol>	1 Application	Sheet
3. Construction54. Characteristics6~134.1 Rated voltage & Surge voltage6~134.2 Capacitance (Tolerance)34.3 Leakage current44.4 tan δ4.5 Impedance4.6 Terminal strength4.7 Temperature characteristic4.8 Load life test4.9 Shelf life test4.10 Surge test4.11 Vibration4.12 Solderability test4.13 Resistance to solder heat4.14 Change of temperature4.15 Damp heat test4.16 Vent test4.17 Maximun permissible (ripple current)5. List of "Environment-related Substances to be Controlled ('Controlled 'Controlled 'Substances')"	1. Application	4
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5. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"		
	5. List of "Environment-related Substances to be Controlled ('Controlled	14
		15~20

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#### 1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

2.	Par	t Numb	oer S	System								
1	2	3 4	56	3 7	r	89	ľ	10 11 12	2 131	14	1516	17
E	G	S 1	0 5	5 N	1	1 H		D11	т	С	SA	Ρ
	SERIES	CAPA	CITAN	CE TO	<u>الـ</u>	VOLTAGE	-	CASE SIZE	TYP	E,	SAMXON	SLEEVE
									I	1	RODUCI LINE N	
	Series	Cap(MFD)	Code	Tolerance (%	) Code	Voltage (W.V.)	Code	Case Size	Feature (	Code	SAMXON Product L	Line
	ESM EKF	0.1	104	± 5	J	2	0D	Diameter(é) Code	Radial bulk	RR	For internal use only	
	ESS EKS	0.00				4	0E 0G		Ammo Tap	ina	(The product lines we have H,A,B,C,D	
	EGS EKM	0.22	224	±10	ĸ	6.3	OJ	5 D 6.3 E			E,M or 0,1,2,3,4,5,9	
	EKG EOM	0.33	334			8	0K 1A	6.3 E 8 F 10 G	2.0mm Pitch	Π		
	EZM EZS	0.47	474	±15	L	12.5	1B	12.5 I 13 J 13.5 V	2.5mm Pitch	тυ		
	EGF ESF		405	±20	м	16 20	1C 1D	14   4	3.5mm Pitch	тν		Contra
	EGT EGK	1	105			25	1E	14.5 A 16 K 16.5 7		$\vdash$	Sleeve Material	
	EGE EGD	2.2	225	±30	N	30 32	1I 13	16.5 7 18 L	5.0mm Pitch	тс	PET	P
	EGC	3.3	335	-40	w	35	1V	18.5 8 20 M	Lead Cut & F	Form		
E	ERF ERL		175	0		40 42	1G 1M	18 L 18.5 8 20 M 22 N 25 O 30 P 34 W 35 Q 40 P	СВ-Туре	СВ	PVC	fthe
	ERR ERT	4.7	475	-20 0	A	50	1H	34 W		$\vdash$		slee
	ERE ERD	10	106	-20		57	1L	40 R 42 4	СЕ-Туре	CE		Ne m
	ERH EBD	22	226	+10	c	63 71	1J 1S	25 O 30 P 34 W 35 Q 40 R 42 4 45 6 51 S 63.5 T	HE-Type	HE		ateria
	ERA ERB			-20 +40	×	75	1 <b>T</b>	63.5 T	KD-Type	кD		I SF
	ERC EFA	33	336			80 85	1K 1R	76 U 80 8 90 X				, č,
	ENP ENH	47	476	-20 +50	S	90	19	90 X 100 Z Len.(mm) Code	FD-Type	FD		there
	ERW	100	107	-10 0	в	100 120	2A 20	4.5 45 5 05	EH-Type	EH		If the sleeve material is PVC, there will be blank in seventeenth digit
	ELP EAP		007	-10		125	2B	5.4 54 7 07	PCB Term	nial		beb
	EQP EDP	220	227	+20	V V	150 160	2Z 2C	10.2 T2		sw		
	ETP EHP EUP	330	337	-10 +30	Q	180	2P	11 11 11.5 1A		500		n sev
	EKP EEP	470	477	-10	т	200 215	2D 22	12 12 12.5 1B 13 13	Snap-in	sx		ente
	EFP ESP	2200	228	+50	<u> </u>	220	2N	13.5 1C		sz		anth
	EVP EGP	2200	228	-5 +10	E	230 250	23 2E	13.5 1C 20 20 25 25	Lug	SG		digit.
	EWR	22000	229	-5 +15	F	275	2T	20 20 25 25 29.5 2J 30 30 31.5 3A 35 35				
	EWT	33000	339			300 310	21 2R	35 35 35 5 25		05		
	EWF	47000	479	+20	G	315	2F	35.5 35 35.5 3E 50 50 80 80 100 1L 105 1K		06		
	EWH EWL			+20	R	330 350	2U 2V	100 1L 105 1K		т5		
	EWB VSS	100000	10T	0	0	360	2X	110 1M 120 1N	Screw	$\vdash$		
	VNS VKS	150000	15T	+30		375 385	2Q 2Y	130 1P 140 1Q		т6		
	VKM VRL	220000	22T	+50	<u> </u>	400	2G	150 1R 155 1E		D5		
	VNH VZS			+5 +15	z	420 450	2M 2W	160 1S 165 1F 170 1T		D6		
	VRF	330000	33T	+5 +20	D	500	2VV 2H	180 10				
		1000000	10M	+20		550 600	25 26	190 1V 200 2L 215 2A				
		1500000	15M	+50	Y	630	20 2J	215 2A 210 2M				
				+10 +30	н			210 2M 210 2M 220 2N 240 2Q 250 2R				
		2200000	22M					250 2R 260 2S 270 2T				
		3300000	33M					210 21				

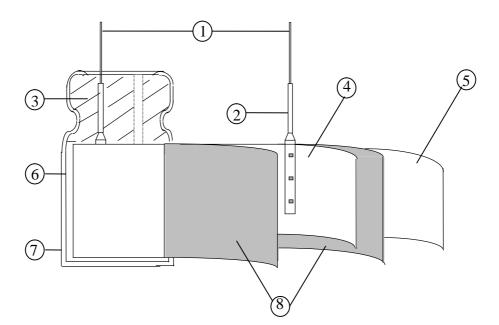
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#### 3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material				
1	Lead Line	Tinned CP wire (Pb Free)				
2	Terminal	Aluminum wire				
3	Sealing Material	Rubber				
4	Al-Foil (+)	Formed aluminum foil				
5	Al-Foil (-)	Etched aluminum foil or formed aluminum foil				
6	Case	Aluminum case				
7	Sleeve	PET				
8	Separator	Electrolyte paper				

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#### 4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature $: 20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2

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ITEM				PE	RFORM	ANCE			
	Rated voltage (WV)	WV (V.DC) SV (V.DC)	6.3 8	10 13	16 20	25 32	35 44	50 63	63 79
4.1	Surge voltage (SV)	WV (V.DC) SV (V.DC)	100 125					L	
4.2	Nominal capacitance (Tolerance)	<condition> Measuring Free Measuring Vol Measuring Te <criteria> Shall be within</criteria></condition>	tage mperature	: Not: e $: 20 \pm$	2℃		5		
4.3	Leakage current	<condition> Connecting the minutes, and th <criteria> Refer to Table</criteria></condition>	ien, meas		-		(1k Ω ±	10Ω) in	series for 2
		<condition> See 4.2, Norm <criteria> Refer to Table</criteria></condition>	-	nnce, for n	neasuring	frequenc	y, voltage	e and tem	perature.
4.4	tan δ								

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		<condition> Tensile Strength of Terminals Fixed the capacitor, applied force to the terminal in lead out direction for 10 ±1 seconds. Bending Strength of Terminals Fixed the capacitor, applied force to bent the terminal (1~4 mm from the rubber) for 90° within 2~3 seconds, and then bent it for 90° to its original position within 2~3 seconds.</condition>						
4.6	Terminal	Diameter of lead wire	Tensile force N (kgf)	Bending force N (kgf)				
	strength	0.5mm and less	5 (0.51)	2.5 (0.25)				
		Over 0.5mm to 0.8mm	10 (1.0)	5 (0.51)				
		<condition> STEP Testing Temperar</condition>	ure(°C) Time					
		1 $20\pm 2$	Time to re	each thermal equilibrium				
		2 -40(-25) ±	3 Time to re	each thermal equilibrium				
		$3  20\pm 2$	Time to re	each thermal equilibrium				
		4 $105\pm 2$	Time to reach thermal equilibrium					
		5 20±2	Time to reach thermal equilibrium					
4.7	Temperature characteristic	<ul> <li><criteria></criteria></li> <li>a. At +105°C, capacitance m of its original value at +2 tan δ shall be within the li The leakage current meas value.</li> <li>b. In step 5, tan δ shall be wi The leakage current shall</li> </ul>	D°C. mit of Item 4.4 sured shall not more thin the limit of Iten	than 8 times of its specified				

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		c. At-40°C (-25°C), impedar						
		Working Voltage (V)	6.3	10	16	25	35	50
		Z-25°C/Z+20°C	4	3	2	2	2	2
		Z-40°C/Z+20°C	8	6	4	3	3	3
.7		Working Voltage (V)	63	100	]			
		Z-25°C/Z+20°C	2	2				
		Z-40°C/Z+20°C	3	3				
		Capacitance, tan $\boldsymbol{\delta}$ , and i	mpedanc	e shall be	e measure	d at 120H	łz.	
		<condition> According to IEC60384</condition>				-		
		temperature of $105^{\circ}C =$			<b>•</b> •			
		$2000+48/0(\Phi D, \Phi 5 \sim \Phi)$	,				,	
		$(\Phi D \ge \Phi 12.5)$ hours. ( rated working voltage)					•	
	Load	time at atmospheric con		-				
.8	life	-					C	
	test	<criteria></criteria>		. 11 .				
		The characteristic shall n						
		Leakage current		$\frac{1}{100}$ $\frac{1}$				
		Capacitance Change $\tan \delta$		$1 \pm 25\%$ c				
						· ·	ed value.	
		Appearance	Inere	shall be n	o leakage	e of electr	olyte.	
		<condition></condition>				_		
		The capacitors are then s	tored wit	th no volta	age applie	ed at a te	mperature	$e \text{ of } 105 \pm 2\%$
		for 1000+48/0 hours. Following this period the	acanacit	ore chall l	ha ramov	ed from t	ha tast ch	ambar and b
		allowed to stabilized at re	-					
		Next they shall be conne					100 Ω ) w	vith D.C. rate
		voltage applied for 30mi			•			
	Shelf	tested the characteristics.						
.9	life	<criteria></criteria>						
	test	The characteristic shall n		ě	<b>.</b>			
		Leakage current		in 4.3 sha				
		Capacitance Change		$\pm 25\%$ c				
		tan δ		ore than 1		•		
		Appearance		shall be n	U		;	
		Remark: If the capacitor increase. Plea						
			Set annuV					

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4.10	Surge test	$\label{eq:conditions} $$ Applied a surge voltage to the capacitor connected with a (100 \pm 50)/C_R (k\Omega) resistor. The capacitor shall be submitted to 1000 cycles, each consisting of charge of 30 \pm 5s, followed discharge of 5 min 30s. The test temperature shall be 15~35 °C. C_{8} :Nominal Capacitance ( \mu F) $$ Criteria> $$ Leakage current Not more than the specified value. Capacitance Change Within \pm 15\% of initial value. tan \delta Not more than the specified value. Appearance There shall be no leakage of electrolyte. $$ Attention: This test simulates over voltage at abnormal situation only. It is not applicable to such over voltage as often applied. $$ \end{tabular}$
4.11	Vibration test	<condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Mounting method: The capacitor with diameter greater than 12.5mm or longer than 25mm must be fixed in place with a bracket. <math display="block">4mm \text{ or less} \qquad </math></condition>

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		<criteria></criteria>	
		After the test, the follow	ving items shall be tested:
		Inner construction	No intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes.
		Appearance	No mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall be legible.
1.12	Solderability test	<condition> The capacitor shall be tes Soldering temperature Dipping depth Dipping speed Dipping time <criteria> Coating quality</criteria></condition>	ted under the following conditions: : 245±3°C : 2mm : 25±2.5mm/s : 3±0.5s A minimum of 95% of the surface being immersed
4.13	Resistance to solder heat test	$260 \pm 5$ °C for $10 \pm 1$ second from the body of capacit	be left under the normal temperature and normal

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		<condition> Temperature Cycle: According to IEC6038 oven, the condition ac</condition>		apacitor shall be placed in an
		Te	mperature	Time
		(1)+20°℃		$\leq 3$ Minutes
		(2)Rated low tempera	ature(-40°C)(-25°C)	$30\pm2$ Minutes
		(3)Rated high temper	ature (+105℃)	$30\pm2$ Minutes
	Change of	(1) to (3)=1 cycle, tot	al 5 cycle	
4.14	temperature test	<criteria>The characteristic shallLeakage currenttan <math>\delta</math>Appearance</criteria>	Not more than theNot more than the	specified value.
4.15	Damp heat test	<condition>Humidity Test:According to IEC60384be exposed for <math>500\pm 8</math><math>40\pm 2^{\circ}</math>C, the characteri<criteria>Leakage currentCapacitance Changetan <math>\delta</math>Appearance</criteria></condition>	hours in an atmosphere stic change shall meet Not more than the spe Within $\pm 20\%$ of init	e of 90~95%R H .at the following requirement. ecified value. tial value. of the specified value.

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		<condition></condition>	1 4 41	1 (	•.1	1 4 4 1	. ,			
		The following test only apply to those products with vent products at diameter $3\sqrt{16}$ a with vent								
		${}^{3}$ Æ6.3 with vent.								
		D.C. test								
		The capacitor is connected w	with its nota	rity reverse	d to a DC r	ower source	- Then			
		a current selected from below			u to a DC p	ower source	c. Then			
			10 10 10	appirear						
		<table 3=""></table>								
110	Vent	Diameter (mm) DC Curr	rent (A)							
4.16	test	22.4 or less 1								
		<criteria></criteria>								
		The vent shall operate with r		us condition	is such as fl	ames or dis	persion			
		of pieces of the capacitor and	d/or case.							
		<condition></condition>								
		The maximum permissible ri	pple curren	t is the max	imum A.C	current				
		at 100kHz and can be applie	d at maxim	um operatii	ng temperat	ure				
		Table-1								
		The combined value of D.C.			.C voltage s	hall not exc	eed the			
		The combined value of D.C. rated voltage and shall not re			.C voltage s	hall not exc	eed the			
		rated voltage and shall not re			.C voltage s	hall not exc	eed the			
		rated voltage and shall not re Frequency Multipliers:			.C voltage s	hall not exc	eed the			
	Mauianum	rated voltage and shall not re Frequency Multipliers: Coefficient Freq.	everse volta	age.	-		eed the			
	Maximum	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz)			.C voltage s	hall not exc 100k	eed the			
4.17	permissible	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. ( µ F)	everse volta	nge.	10k	100k	eed the			
4.17		rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180	120 0.40	1k 0.75	10k 0.90	100k 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560	120 0.40 0.50	1k 0.75 0.85	10k 0.90 0.94	100k 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800	120 0.40 0.50 0.60	1k 0.75 0.85 0.87	10k 0.90 0.94 0.95	100k 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800 2200~3900	120 0.40 0.50 0.60 0.75	1k 0.75 0.85 0.87 0.90	10k 0.90 0.94 0.95 0.95	100k 1.00 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800	120 0.40 0.50 0.60	1k 0.75 0.85 0.87	10k 0.90 0.94 0.95	100k 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800 2200~3900	120 0.40 0.50 0.60 0.75	1k 0.75 0.85 0.87 0.90	10k 0.90 0.94 0.95 0.95	100k 1.00 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800 2200~3900	120 0.40 0.50 0.60 0.75	1k 0.75 0.85 0.87 0.90	10k 0.90 0.94 0.95 0.95	100k 1.00 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800 2200~3900	120 0.40 0.50 0.60 0.75	1k 0.75 0.85 0.87 0.90	10k 0.90 0.94 0.95 0.95	100k 1.00 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800 2200~3900	120 0.40 0.50 0.60 0.75	1k 0.75 0.85 0.87 0.90	10k 0.90 0.94 0.95 0.95	100k 1.00 1.00 1.00 1.00	eed the			
4.17	permissible (ripple	rated voltage and shall not re Frequency Multipliers: Coefficient Freq. (Hz) Cap. (µF) ~180 220~560 680~1800 2200~3900	120 0.40 0.50 0.60 0.75	1k 0.75 0.85 0.87 0.90	10k 0.90 0.94 0.95 0.95	100k 1.00 1.00 1.00 1.00	eed the			

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# 6.It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances					
	Cadmium and cadmium compounds					
Heavy metals	Lead and lead compounds					
Heavy metals	Mercury and mercury compounds					
	Hexavalent chromium compounds					
	Polychlorinated biphenyls (PCB)					
Chloinated	Polychlorinated naphthalenes (PCN)					
organic	Polychlorinated terphenyls (PCT)					
compounds	Short-chain chlorinated paraffins(SCCP)					
	Other chlorinated organic compounds					
	Polybrominated biphenyls (PBB)					
Brominated .	Polybrominated diphenylethers(PBDE) (including decabromodipheny					
organic	ether[DecaBDE])					
compounds	Other brominated organic compounds					
Tributyltin comp	ounds(TBT)					
Triphenyltin con	apounds(TPT)					
Asbestos						
Specific azo com	pounds					
Formaldehyde						
Beryllium oxide						
Beryllium copp	er					
Specific phthalat	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)					
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)					
Perfluorooctane	sulfonates (PFOS)					
Specific Benzotr	iazole					

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#### **Attachment: Application Guidelines**

#### **1.Circuit Design**

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at  $20^{\circ}$ C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
  - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
  - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
  - a) At higher frequencies capacitance and impedance decrease while tan  $\delta$  increases.
  - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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#### (1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

#### (3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

- (2) Capacitors Connected in Series Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.
- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

#### (2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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<ul> <li>(4) Clearance for Case Mounted Pressure Relief vents</li> <li>Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.</li> <li>φ 6.3~ φ 16mm:2mm minimum, φ 18~ φ 35mm:3mm minimum, φ 40mm or greater:5mm minimum.</li> </ul>
<ul><li>(5) Clearance for Seal Mounted Pressure Relief Vents</li><li>A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.</li></ul>
(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
<ul> <li>(7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.</li> </ul>
<ul> <li>(8) Screw Terminal Capacitor Mounting</li> <li>Do not orient the capacitor with the screw terminal side of the capacitor facing downwards.</li> <li>Tighten the terminal and mounting bracket screws within the torque range specified in the specification.</li> </ul>
<ol> <li>1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows.</li> <li>(1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths</li> <li>(2) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.</li> </ol>
<ul> <li>1.7 The Product endurance should take the sample as the standard.</li> <li>1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling.</li> <li>1.9 Capacitor Sleeve <ul> <li>The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor.</li> <li>The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.</li> </ul> </li> </ul>
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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#### 2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about  $1k \Omega$ .
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately  $1k \Omega$ .
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- \* (1) Verify the correct capacitance and rated voltage of the capacitor.
- \* (2) Verify the correct polarity of the capacitor before inserting.
- \* (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
  (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

#### 2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400  $^{\circ}$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

#### 2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

#### 2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed  $150^{\circ}$ C for a maximum time of 2 minutes.

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#### 2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- \* (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to  $60^{\circ}$ C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- \* (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- Petroleum based solvents: deterioration of the rubber seal could result.
- Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- \* (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- \* (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

#### 3. Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- \* (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- \* (2) Direct contact with water, salt water, or oil.
- \* (3) High humidity conditions where water could condense on the capacitor.

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- \* (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- \* (5) Exposure to ozone, radiation, or ultraviolet rays.
- \* (6) Vibration and shock conditions exceeding specified requirements.

#### **3.2 Electrical Precautions**

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

#### 4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water. If electrolyte or gas is ingested by month, gargle with water. If electrolyte contacts the skin, wash with soap and water.

#### 5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a  $1000 \Omega$ , current limiting resistor for a time period of 30 minutes .

If the expired date of products date code is over eighteen months, the products should be return to confirmation. 5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

#### 6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

\* Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.

\* Dispose of as solid waste. NOTE: Local laws may have specific disposal requirements, which must be followed.

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